

NOT RECOMMENDED FOR NEW DESIGN USE PDS360

MBRM360

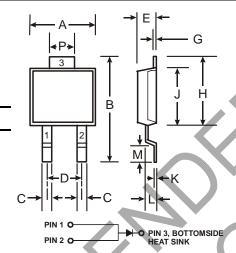
3A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER POWERMITE®3

Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Reverse Current
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Lead Free Finish/RoHS Compliant Version (Note 2)

Mechanical Data

- Case: POWERMITE®3
- Case Material: Molded Plastic: UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish). (63)
- Polarity: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.072 grams (approximate)



POWERMITE®3 Dim Min Max 4.03 4.09 Α В 6.40 6.61 .889 NOM C 1.83 NOM Ε 1.10 1.14 G .178 NOM 5.01 5.17 4.37 4.43 Κ .178 NOM .71 .77 .36 M .46 1.83 1.73 All Dimensions in mm

Note:

Pins 1 & 2 must be electrically connected at the printed circuit board.

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	60	V
RMS Reverse Voltage	V _{R(RMS)}	42	V
Average Rectified Output Current (See also Figure 5)	I ₀	3	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	I _{FSM}	100 50	Α
Typical Thermal Resistance Junction to Soldering Point	$R_{ heta JS}$	3.2	°C/W
Operating Temperature Range	T _i	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics @TA = 25°C unless otherwise specified

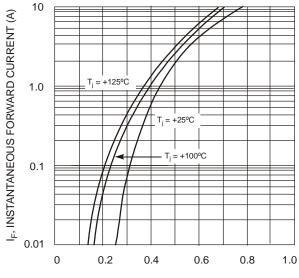
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	$V_{(BR)R}$	60	_	_	٧	$I_R = 0.2 \text{mA}$
¥			0.59	0.63		$I_F = 3A, T_j = 25^{\circ}C$
Forward Voltage	V _{FM}	_	0.53	0.57	•	$I_F = 3A, T_j = 125^{\circ}C$
		_	0.72	0.76		$I_F = 6A, T_j = 25^{\circ}C$
			0.63	0.67		$I_F = 6A, T_j = 125^{\circ}C$
			2.0	200	μΑ	$T_j = 25^{\circ}C, V_R = 60V$
Reverse Current (Note 1)	I_{RM}	_	0.6	20	mA	$T_i = 100^{\circ}C, V_R = 60V$
		_	2.5	150	mA	$T_i = 125$ °C, $V_R = 60$ V
Total Capacitance	C _T		130	_	pF	$f = 1.0MHz$, $V_R = 4.0V DC$

Notes:

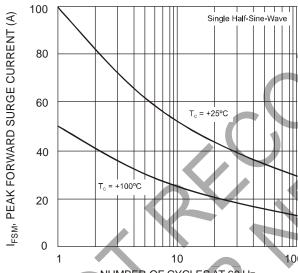
- 1. Short duration pulse test used to minimize self-heating effect.
- 2. EU Directive 2002/95/EC (RoHS). All applicable RoHŠ exemptions applied, see EU Directive 2002/95/EC Annex Notes.



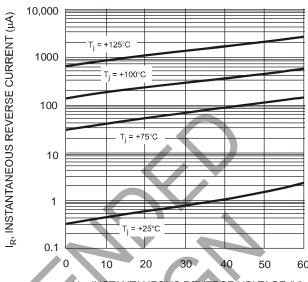
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V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 1 Typical Forward Characteristics



NUMBER OF CYCLES AT 60 Hz
Fig. 3 Max Non-Repetitive Peak Forward Surge Current



V_R, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 2 Typical Reverse Characteristics

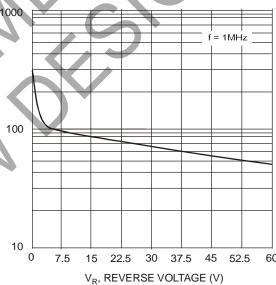
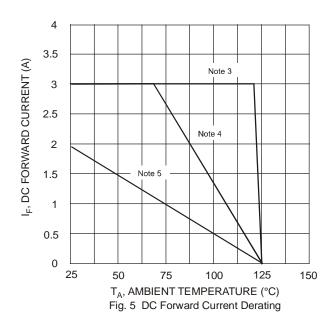


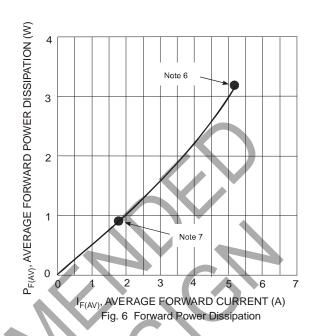
Fig. 4 Typical Capacitance vs. Reverse Voltage

OTAL CAPACITANCE (pF)



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Notes:

- $T_A = T_{SOLDERING POINT}$, $R_{\theta JS} = 3.2^{\circ}C/W$, $R_{\theta SA} = 0^{\circ}C/W$.
- Device mounted on GETEK substrate, 2"x2", 2 oz. copper, double-sided, cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". $\,R_{\theta JA}$ in range of 20-40°C/W.
- Device mounted on FR-4 substrate, 2"x2", 2 oz. copper, single-sided, pad layout as per Diodes Inc. suggested pad layout document AP02001 which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. $R_{\theta JA}$ in range of
- Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 4. Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 5.

Ordering Information (Note 8)

Device	Packaging	Shipping		
MBRM360-13-F	POWERMITE®3	5000/Tape & Reel		

8. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



MBRM360 = Product type marking code Wishingto = Product type Infaming does

I'l = Manufacturers' code marking

YYWW = Date code marking

YY = Last digit of year (ex: 02 for 2002)

WW = Week code (01 to 53)

(K) = Factory Designator



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